EVA hot melt adhesive · unfilled

**Application:** For wrapping profiles made of solid wood, particleboard or MDF, with veneer and CPL.

**Characteristics/Directions for Use:**
- Long open time, high hot tack, good heat resistance. Good resistance to oxidation and colour stability in the melt.
- Can be processed on automatic units with roller.

Processing temperature [°C]: 180 – 200
Feed speed [m/min]: 18 – 50
Appearance: yellow translucent
Density at 20 °C [g/cm³]: approx. 1.03 ± 0.03 (Jowat test method)
Softening range [°C]: approx. 90 ± 5 (Kofler bench)
Open time at 190 °C [s]: approx. 5 ± 2 (Jowat test method)
Setting time: not applicable

The properties of the substrates and the processing conditions will influence the processes of joining and bonding. Customer trials before use are therefore recommended.

The materials to be used must be free of grease and dust and be dry, they also have to match perfectly. Wood moisture content should be at 8 – 10 %. Minimum temperature of substrates and ambient air should not be below 18 °C. Avoid draught.

**Specification:**
- Viscosity at 200 °C [mPas]: 50,500 ± 12,500 (Brookfield, Thermosel, spindle 29, 10 rpm)

**Cleaning:**
- Preliminary cleaning while hot by scraping with a spatula. Remove any residues when cold with Jowat® Cleaner 402.40.

**Storage:**
- Cool and dry.
- Best-before date, please refer to label on the packaging unit.

**Packaging:**
- Granulate. Types of packaging and units upon request.

**Remarks:**
- For further information concerning safety, handling, transport and disposal, please refer to the Safety Data Sheet.

Our information on this data sheet is based on test results from our laboratories as well as on experience gained in the field by our customers. It can, however, not cover all parameters for each specific application and is therefore not binding for us. The information given in this leaflet represents neither a performance guarantee nor a guarantee of properties, nature, condition, state or quality. No liability may be derived from these indications nor from the recommendations made by our free technical advisory service.
Jowat Information

Gluing as one of the most efficient methods of bonding is constantly gaining importance and expanding into new areas of application. At the same time, the number of substrates to be bonded is also growing at an unprecedented rate. New methods and equipment to process adhesives are developed.

The in-house R & D departments of Jowat are responding with intensive efforts to keep pace with these constant changes. A highly qualified team of chemists and engineers is using the latest techniques and brightest ideas to provide the utmost in advice our customers and to make sure that they get the adhesive which meets their needs.

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The processing company itself must therefore test the adhesives manufactured by us for suitability in each individual case. This applies to the first use of a sample as well as to modifications during an ongoing production.

We are therefore requesting all our new customers to test our adhesives for suitability on original parts at conditions equal to normal processing conditions. The bond has then to be subjected to the actual stress which it would undergo when in use and has to be assessed. This test is absolutely necessary.

Customers who undertake modifications during a running production are requested to pass this information on to us. Please notify us when machines are set to new parameters as well as when the substrates to be bonded are changed. Only then will Jowat be able to provide our most up-to-date information to the processor using our adhesives.

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